

Thermal Resistance-Based Bounds for the Effective Conductivity of Composite Thermal Interface Materials

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Outline



- Motivation
- Problem statement
- Model development
- Numerical and experimental validation
- Conclusions
- Future work

Motivation



- Thermally enhanced greases used as thermal interface materials (TIMs) in microelectronics cooling applications Q
- Thermal resistance, R, of TIMs required for thermal models



BLT

TIN



- To develop analytical models for effective thermal conductivity of fluidic composite materials
- Account for particle-particle interactions \rightarrow good agreement for high and low particle volume fractions (Φ)



Model: Assumptions



- 1. N uniform spherical particles, N >> 1
- 2. arranged in cubic lattice with
- 3. perfect thermal contact between phases and
- 4. isotropic and constant thermal conductivities

Model: Characteristic Cell



• The assumptions allow one to consider a *characteristic cell*



Model: Bounds



- Lower bound on k_e: Parallel adiabats
- Upper bound on k_e: Perpendicular isotherms



Numerical Results



• Model validated for

Volume fractions, $\Phi = 0.1, 0.2, 0.3, 0.4, 0.45$ Conductivity ratios, $\kappa = 10, 100, 1000$



Numerical Results (cont'd)



- Geometric mean of bounds gives good agreement
- Physically, adiabats are neither parallel nor isotherms perpendicular, though numerical results indicate parallel adiabats more realistic



Experimental Results



- Model validated with experimental data in literature
- Geometric mean gives very good agreement, even when particles are irregular (non-spherical)



(Wong and Bollampaly, 1999)

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Experimental Results (cont'd)



¹(Sundstrom and Chen, 1970) ²(Lin, Bhatia, and Ford, 1993) ³(Tavman, 2000)

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Summary and Conclusions



Model gives very good agreement with

- (i) Numerical results
 - Model consistently overpredicts numerical results
 - Parallel adiabats more realistic model
- (ii) Experimental results
 - Even when particles are irregular

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\begin{array}{l} 0.1 \leq \Phi \leq 0.45 \\ 10 \leq \kappa \leq 1000 \end{array}
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Extend the present analysis to

- 1. a general rectangular lattice arrangement \rightarrow particle distribution,
- 2. various particle geometries (e.g. ellipsoids, prismoids, right circular cylinders, etc.) \rightarrow particle alignment, and
- 3. imperfect thermal contact between particle and matrix (e.g. oxides)

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